Surface Mount Schottky Power Rectifier

Plastic SOD-123 Package

This device uses the Schottky Barrier principle with a large area metal-to-silicon power diode. Ideally suited for low voltage, high frequency rectification or as free wheeling and polarity protection diodes in surface mount applications where compact size and weight are critical to the system. This package also provides an easy to work with alternative to leadless 34 package style. Because of its small size, it is ideal for use in portable and battery powered products such as cellular and cordless phones, chargers, notebook computers, printers, PDAs and PCMCIA cards. Typical applications are AC-DC and DC-DC converters, reverse battery protection, and "Oring" of multiple supply voltages and any other application where performance and size are critical.



- Guardring for Stress Protection
- Low Forward Voltage
- 125°C Operating Junction Temperature
- Epoxy Meets UL 94 V-0
- Package Designed for Optimal Automated Board Assembly
- ESD Ratings: Machine Model, C Human Body Model, 3B
- This is a Pb-Free Device

Mechanical Characteristics

• Reel Options: MBR230LSFT1 = 3,000 per 7 in reel/8 mm tape

• Device Marking: L3N

Polarity Designator: Cathode BandWeight: 11.7 mg (approximately)

• Case: Epoxy, Molded

• Lead Finish: 100% Matte Sn (Tin)

• Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds

• Device Meets MSL 1 Requirements



ON Semiconductor®

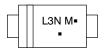
http://onsemi.com

SCHOTTKY BARRIER RECTIFIER 2.0 AMPERES, 30 VOLTS



SOD-123FL CASE 498 PLASTIC

MARKING DIAGRAM



L3N = Specific Device Code

M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device		Package	Shipping [†]
MBR230LSFT1	G	SOD-123FL (Pb-Free)	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

Preferred devices are recommended choices for future use and best overall value.

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	30	V
Average Rectified Forward Current (At Rated V _R , T _L = 105°C)	Io	2.0	Α
Peak Repetitive Forward Current (At Rated V _R , Square Wave, 100 kHz, T _L = 95°C)	I _{FRM}	4.0	А
Non-Repetitive Peak Surge Current (Non-Repetitive peak surge current, halfwave, single phase, 60 Hz)	I _{FSM}	40	А
Storage Temperature	T _{stg}	-55 to 150	°C
Operating Junction Temperature	TJ	-55 to 125	°C
Voltage Rate of Change (Rated V _R , T _J = 25°C)	dv/dt	10,000	V/μs

THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Lead (Note 1)	R _{til}	26	°C/W
Thermal Resistance, Junction-to-Lead (Note 2)	R _{til}	21	
Thermal Resistance, Junction-to-Ambient (Note 1)	R _{tia}	325	
Thermal Resistance, Junction-to-Ambient (Note 2)	R _{tja}	82	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Mounted with minimum recommended pad size, PC Board FR4.

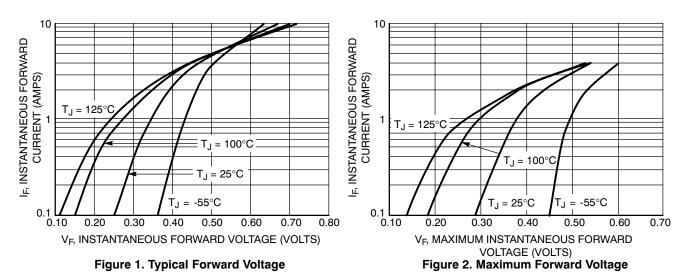
- 2. Mounted with 1 in. copper pad (Cu area 700 mm²).

ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (Note 3)	V _F	T _J = 25°C	T _J = 100°C	٧
(I _F = 1.0 A) (I _F = 2.0 A)		0.38 0.43	0.30 0.37	
Maximum Instantaneous Reverse Current (Note 3)	I _R	T _J = 25°C	T _J = 100°C	mA
$(V_R = 30 \text{ V})$		1.0	25	

^{3.} Pulse Test: Pulse Width \leq 250 μ s, Duty Cycle \leq 2%.

TYPICAL CHARACTERISTICS



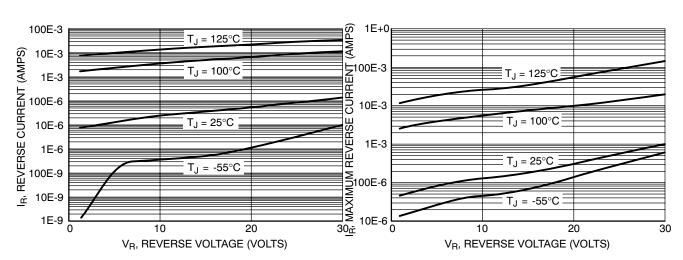


Figure 3. Typical Reverse Current

Figure 4. Maximum Reverse Current

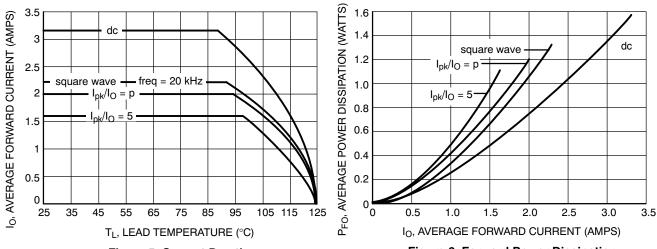
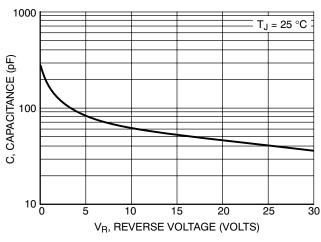


Figure 5. Current Derating

Figure 6. Forward Power Dissipation

TYPICAL CHARACTERISTICS



T_J, DERATED OPERATING TEMPERATURE (°C) 125 $R_{\theta JA} = 25.6 \, ^{\circ}C/W$ 120 115 110 R_{θJA} = 130 °C/W 105 100 95 90 $R_{\theta JA}$ = 235 °C/W 85 80 $R_{\theta JA}$ = 324.9 °C/W 75 70 $R_{\theta JA}$ = 400 °C/W 65 L 12 10 V_R, DC REVERSE VOLTAGE (VOLTS)

Figure 7. Capacitance

Figure 8. Typical Operating Temperature Derating

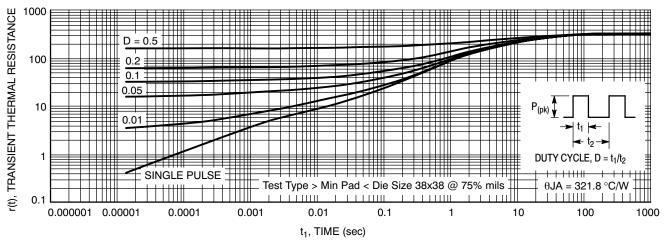
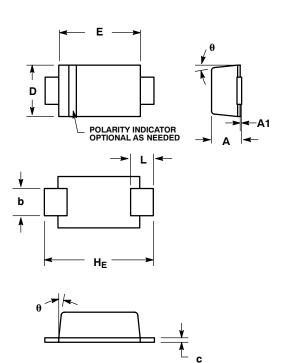


Figure 9. Thermal Response

PACKAGE DIMENSIONS

SOD-123LF CASE 498-01 **ISSUE A**



- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

- 1982.

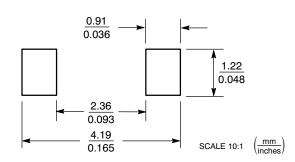
 CONTROLLING DIMENSION: MILLIMETER.

 DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH.

 DIMENSIONS D AND J ARE TO BE MEASURED ON FLAT SECTION OF THE LEAD: BETWEEN 0.10 AND 0.25 MM FROM THE LEAD TIP

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.90	0.95	1.00	0.035	0.037	0.039
A1	0.00	0.05	0.10	0.000	0.002	0.004
b	0.70	0.90	1.10	0.028	0.035	0.043
С	0.10	0.15	0.20	0.004	0.006	0.008
D	1.50	1.65	1.80	0.059	0.065	0.071
E	2.50	2.70	2.90	0.098	0.106	0.114
L	0.55	0.75	0.95	0.022	0.030	0.037
HE	3.40	3.60	3.80	0.134	0.142	0.150
θ	0°	-	8°	0°	-	8°

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and un are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice on semiconductor and are registered raderians of semiconductor Components industries, LC (SCILLC) - Scillute services in english to make changes without further induce to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA

Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada **Fax**: 303-675-2176 or 800-344-3867 Toll Free USA/Canada

Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada

Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5773-3850

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative